

NTR0202PL, NVTR0202PL

MOSFET – Power, P-Channel, SOT-23

-20 V, -400 mA

Features

- Low $R_{DS(on)}$ Provides Higher Efficiency and Extends Battery Life
 $R_{DS(on)} = 0.80 \Omega$, $V_{GS} = -10 \text{ V}$
 $R_{DS(on)} = 1.10 \Omega$, $V_{GS} = -4.5 \text{ V}$
- Miniature SOT-23 Surface Mount Package Saves Board Space
- NVT Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- DC-DC Converters
- Computers
- Printers
- PCMCIA Cards
- Cellular and Cordless Telephones

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	-20	V
Gate-to-Source Voltage – Continuous	V_{GS}	± 20	V
Continuous Drain Current @ $T_A = 25^\circ\text{C}$ Pulsed Drain Current ($t_p \leq 10 \mu\text{s}$)	I_D I_{DM}	-0.4 -1.0	A
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 1)	P_D	225	mW
Operating and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$
Thermal Resistance – Junction-to-Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Source Current (Body Diode)	I_S	0.4	A
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 s	T_L	260	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

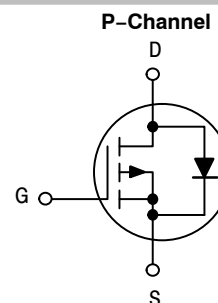
1. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.



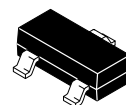
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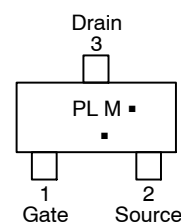
$V_{(BR)DSS}$	$R_{DS(on)}$ Typ	I_D MAX
-20 V	550 m Ω @ -10 V	-400 mA



MARKING DIAGRAM & PIN ASSIGNMENT



**SOT-23
CASE 318
STYLE 21**



PL = Specific Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping†
NTR0202PLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NTR0202PLT3G	SOT-23 (Pb-Free)	10000 / Tape & Reel
NVTR0202PLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NTR0202PL, NVTR0202PL

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain-to-Source Breakdown Voltage ($V_{GS} = 0\text{ V}$, $I_D = -10\ \mu\text{A}$) (Positive Temperature Coefficient)	$V_{(BR)DSS}$	-20	33		V mV/ $^\circ\text{C}$
Zero Gate Voltage Drain Current ($V_{DS} = -20\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 25^\circ\text{C}$) ($V_{DS} = -20\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 150^\circ\text{C}$)	I_{DSS}			-1.0 -10	μA
Gate-Body Leakage Current ($V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{ V}$)	I_{GSS}			± 100	nA
ON CHARACTERISTICS (Note 2)					
Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = -250\ \mu\text{A}$) (Negative Temperature Coefficient)	$V_{GS(th)}$	-1.1	-1.9 3.0	-2.3	V mV/ $^\circ\text{C}$
Static Drain-to-Source On-Resistance ($V_{GS} = -10\text{ V}$, $I_D = -200\text{ mA}$) ($V_{GS} = -4.5\text{ V}$, $I_D = -50\text{ mA}$)	$R_{DS(on)}$		0.55 0.80	0.80 1.10	Ω
Forward Transconductance ($V_{DS} = -10\text{ V}$, $I_D = -200\text{ mA}$)	g_{fs}		0.5		Mhos
DYNAMIC CHARACTERISTICS					
Input Capacitance	$(V_{DS} = -5.0\text{ V}$, $V_{GS} = 0\text{ V}$, $F = 1.0\text{ MHz}$)	C_{iss}	70		pF
Output Capacitance		C_{oss}	74		
Reverse Transfer Capacitance		C_{rss}	26		
SWITCHING CHARACTERISTICS (Note 3)					
Turn-On Delay Time	$(V_{DD} = -15\text{ V}$, $I_D = -200\text{ mA}$, $V_{GS} = -10\text{ V}$, $R_G = 6.0\ \Omega$)	$t_{d(on)}$	3.0		ns
Rise Time		t_r	6.0		
Turn-Off Delay Time		$t_{d(off)}$	18		
Fall Time		t_f	4		
Total Gate Charge	$(V_{DS} = -15\text{ V}$, $I_D = -200\text{ mA}$, $V_{GS} = -10\text{ V}$)	Q_{TOT}	2.18		nC
Gate-Source Charge		Q_{GS}	0.41		
Gate-Drain Charge		Q_{GD}	0.40		
BODY-DRAIN DIODE CHARACTERISTICS (Note 2)					
Diode Forward Voltage (Note 2) ($I_S = -400\text{ mA}$, $V_{GS} = 0\text{ V}$) ($I_S = -400\text{ mA}$, $V_{GS} = 0\text{ V}$, $T_J = 150^\circ\text{C}$)	V_{SD}		-0.8 -0.65	-1.0	V
Reverse Recovery Time	$(I_S = -1.0\text{ A}$, $V_{GS} = 0\text{ V}$, $di_S/dt = 100\text{ A}/\mu\text{s}$)	t_{rr}	11.8		ns
		t_a	9		
		t_b	3		
Reverse Recovery Stored Charge	$(I_S = -1.0\text{ A}$, $V_{GS} = 0\text{ V}$, $di_S/dt = 100\text{ A}/\mu\text{s}$)	Q_{RR}	0.007		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2\%$.

3. Switching characteristics are independent of operating junction temperature.

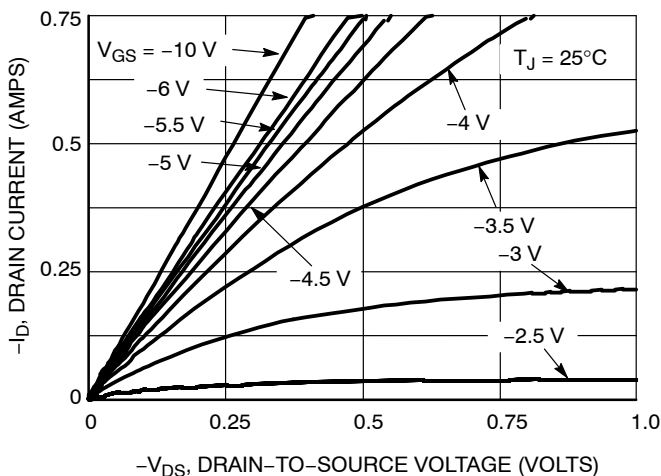


Figure 1. On-Region Characteristics

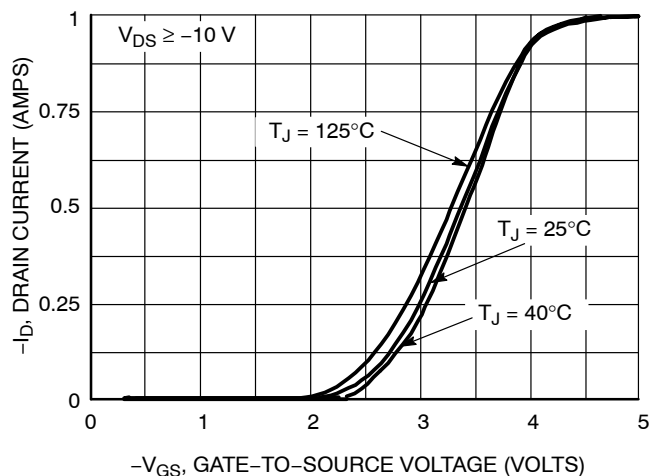


Figure 2. Transfer Characteristics

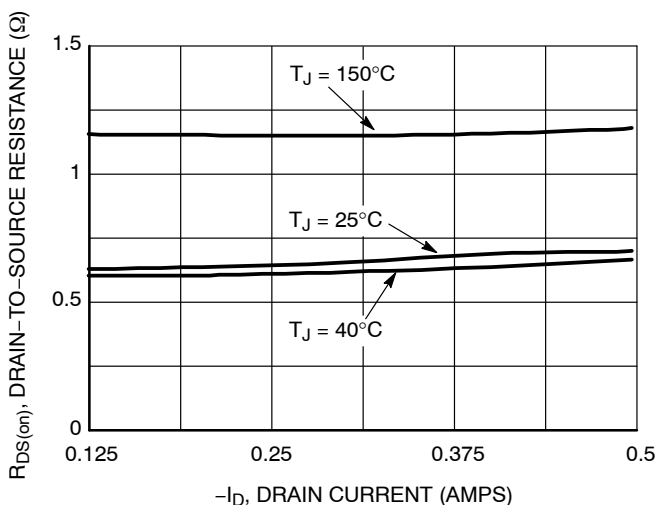


Figure 3. On-Resistance versus Drain Current

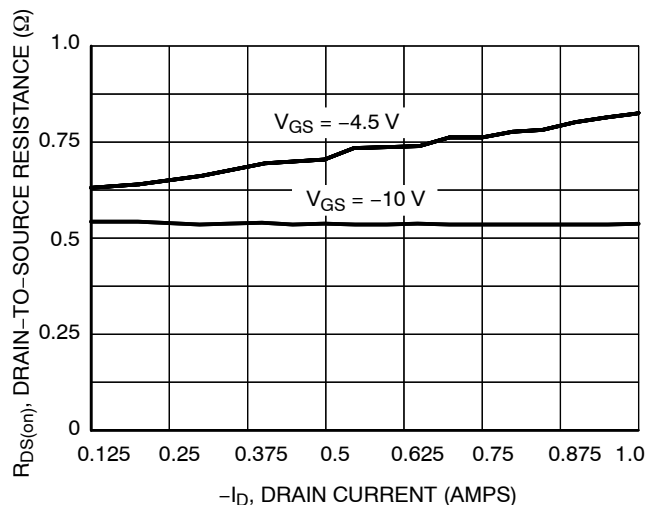


Figure 4. On-Resistance versus Drain Current and Gate Voltage

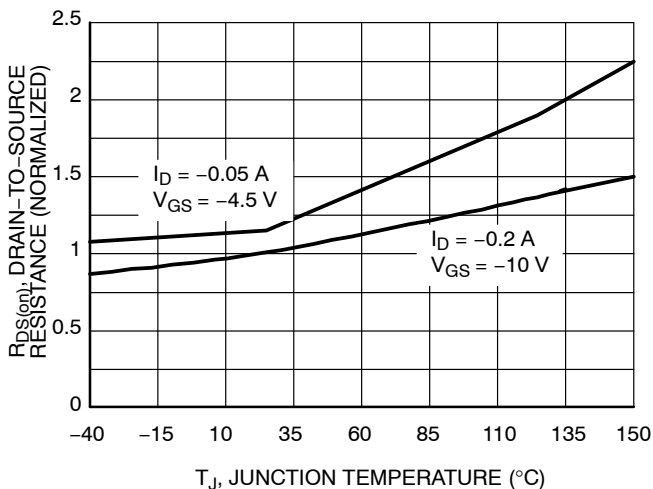


Figure 5. On-Resistance Variation with Temperature

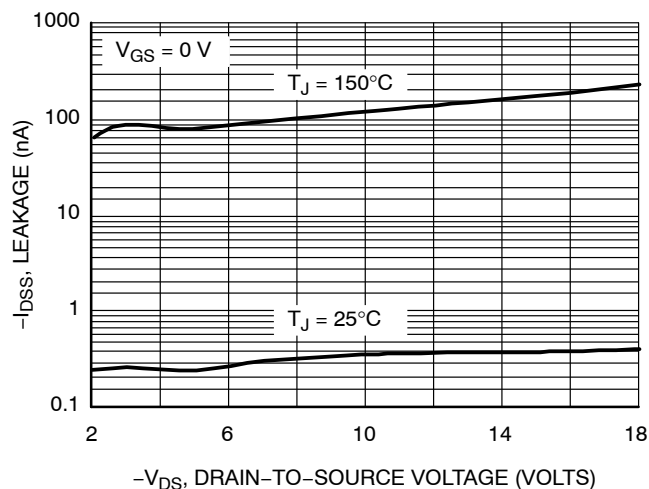


Figure 6. Drain-to-Source Leakage Current versus Voltage

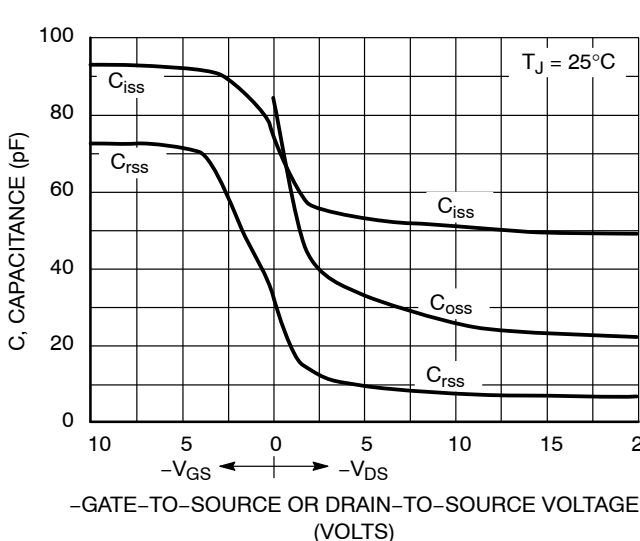


Figure 7. Capacitance Variation

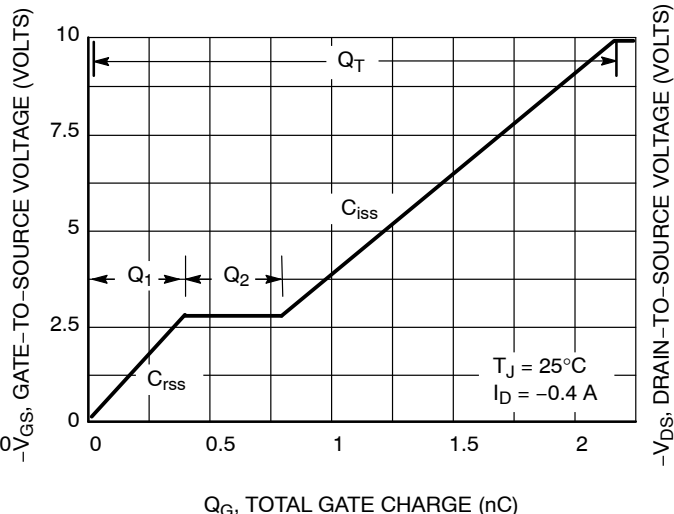


Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Gate Charge

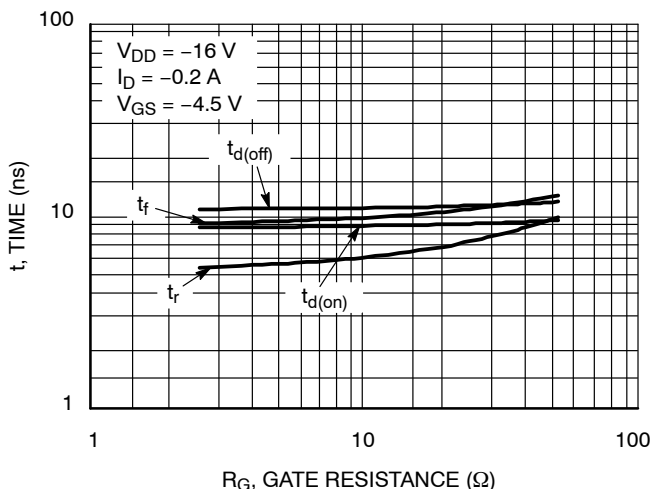


Figure 9. Resistive Switching Time Variation versus Gate Resistance

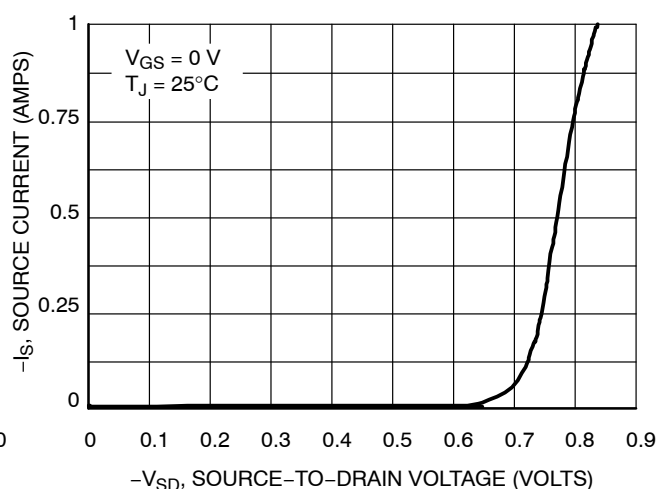


Figure 10. Diode Forward Voltage versus Current

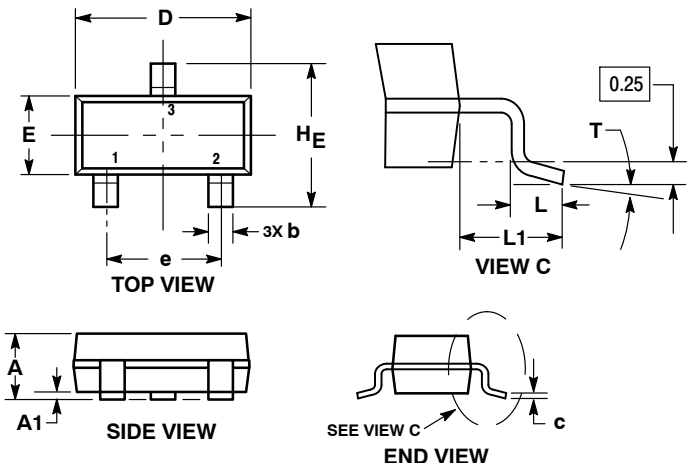
NTR0202PL, NVTR0202PL

PACKAGE DIMENSIONS

SOT-23 (TO-236)

CASE 318-08

ISSUE AR



NOTES:

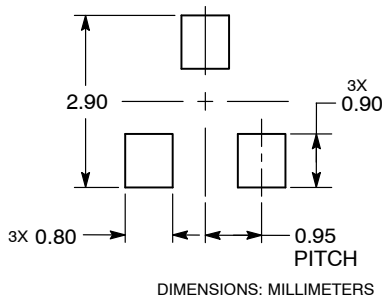
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
c	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
T	0°	---	10°	0°	---	10°

STYLE 21:

1. GATE
2. SOURCE
3. DRAIN

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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